



## **BAV3004W**

June 2008

© Diodes Incorporated

#### SURFACE MOUNT LOW LEAKAGE DIODE

### **Features**

- Surface Mount Package Ideally Suited for Automated Insertion
- Low Leakage Current
- Fast Switching Speed
- High Reverse Breakdown Voltage
- Lead, Halogen and Antimony Free, RoHS Compliant "Green" Device (Notes 1 and 4)
- Qualified to AEC-Q101 Standards for High Reliability

### **Mechanical Data**

- Case: SOD-123
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Solderable per MIL-STD-202, Method 208
- Lead Free plating (Matte Tin Finish annealed over Alloy 42 leadframe)
- Polarity: Cathode Band
- Marking Information: See Page 2
- Ordering Information: See Page 2
- Weight: 0.01 grams (approximate)

SOD-123



TOP VIEW

## **Maximum Ratings** @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit	
Peak Repetitive Reverse Voltage		$V_{RRM}$	350	V
Working Peak Reverse Voltage DC Blocking Voltage		V <sub>RWM</sub> V <sub>R</sub>	300	V
RMS Reverse Voltage		V <sub>R(RMS)</sub>	212	V
Forward Continuous Current		I <sub>FM</sub>	225	mA
Repetitive Peak Forward Current		I <sub>FRM</sub>	625	mA
Non-Repetitive Peak Forward Surge Current	@ t = 1.0μs @ t = 1.0s	I <sub>FSM</sub>	4.0 1.0	А

## Thermal Characteristics

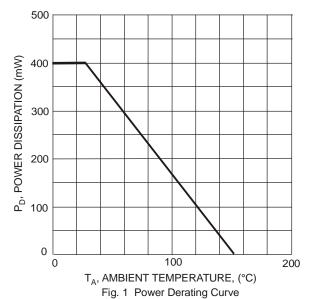
Characteristic	Symbol	Value	Unit
Power Dissipation (Note 3)	$P_{D}$	400	mW
Thermal Resistance Junction to Ambient Air (Note 3)	$R_{ heta JA}$	312	°C/W
Operating and Storage Temperature Range	$T_J,T_STG$	-65 to +150	°C

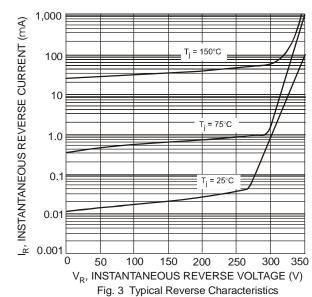
## Electrical Characteristics @TA = 25°C unless otherwise specified

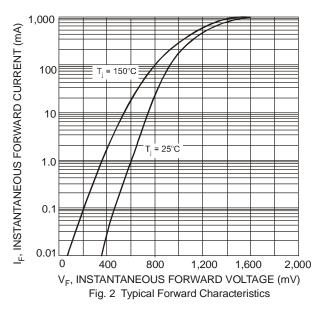
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 2)	V <sub>(BR)R</sub>	350	_	_	V	I <sub>R</sub> = 150μA
Forward Voltage	V <sub>FM</sub>	_	0.78 0.93 1.03	0.87 1.0 1.25	٧	I <sub>F</sub> = 20mA I <sub>F</sub> = 100mA I <sub>F</sub> = 200mA
Leakage Current (Note 2)	I <sub>RM</sub>	_	30 35	100 100		$V_R = 240V, T_J = 25$ °C $V_R = 240V, T_J = 150$ °C
Total Capacitance	CT	_	1.0	5.0	pF	$V_R = 0, f = 1.0MHz$
Reverse Recovery Time	t <sub>rr</sub>	_		50	ns	$I_F = I_R = 30 \text{mA},$ $I_{rr} = 3.0 \text{mA}, R_L = 100 \Omega$

- 1. No purposefully added lead. Halogen and Antimony Free.
- 2. Short duration pulse test used to minimize self-heating effect.
- Part mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
  Product manufactured with Data Code V9 (week 33, 2008) and newer are built with Green Molding Compound. Product manufactured prior to Date Code V9 are built with Non-Green Molding Compound and may contain Halogens or Sb<sub>2</sub>O<sub>3</sub> Fire Retardants.









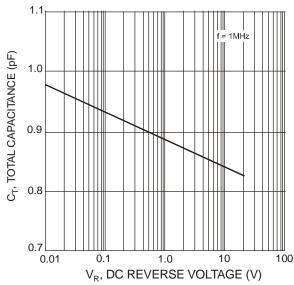


Fig. 4 Total Capacitance vs. Reverse Voltage

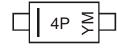
## Ordering Information (Note 5)

Part Number	Case	Packaging
BAV3004W-7-F	SOD-123	3000/Tape & Reel

Notes:

5. For packaging details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

# **Marking Information**



4P = Product Type Marking Code YM = Date Code Marking Y = Year (ex: T = 2006) M = Month (ex: 9 = September)

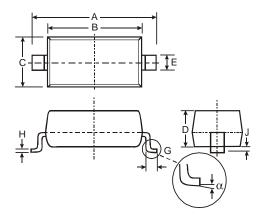
Date Code Key

zate ecae itej													
Year	2002	2003	2004	200	5 20	06 2	2007	20	08 2	2009	2010	2011	2012
Code	N	Р	R	S		Γ	U	١	/	W	Χ	Υ	Z
Month	Jan	Feb	Mar	Apr	May	Jun	Ju	ı	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7		8	9	0	N	D

Downloaded from Elcodis.com electronic components distributor

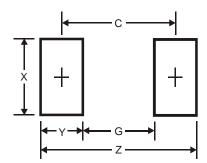


## **Package Outline Dimensions**



	SOD-123					
Dim	Min	Max	Тур			
Α	3.55	3.85	3.65			
В	2.55	2.85	2.65			
С	1.40	1.70	1.55			
D	1.00	1.35	1.05			
Е	-		0.55			
G	0.25	0.40	0.30			
Н	0.10	0.15	0.11			
J		0.10	0.05			
α	0	8°	_			
All D	All Dimensions in mm					

## **Suggested Pad Layout**



Dimensions	Value (in mm)
Z	4.9
G	2.5
X	0.7
Y	1.2
С	3.7

#### IMPORTANT NOTICE

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to any product herein. Diodes Incorporated does not assume any liability arising out of the application or use of any product described herein; neither does it convey any license under its patent rights, nor the rights of others. The user of products in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on our website, harmless against all damages.

#### LIFE SUPPORT

Diodes Incorporated products are not authorized for use as critical components in life support devices or systems without the expressed written approval of the President of Diodes Incorporated.